



PATENT APPLICATION
Docket No. 9903-067
Client no. S02US034

IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Hyun-Ho Kim, et al.
Serial No. 10/620,745 Examiner: not yet assigned
Filed: July 15, 2003 Group Art Unit: 2811
For: IN-LINE DIE ATTACHING AND CURING APPARATUS
FOR A MULTI-CHIP PACKAGE
Confirmation No. 8977

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

This Information Disclosure Statement is submitted:

☒ under 37 CFR 1.97 (b); or
(Within three months of filing national application; or date of entry of International application;
or before mailing date of first office action on the merits; whichever occurs last)

☐ under 37 CFR 1.97 (c) together with either a:
☐ Statement under 37 CFR 1.97 (e), or
☐ a \$180 fee under 37 CFR 1.17 (p); or
(After mailing of first Office Action, but prior to Notice of Allowance or Final Office Action)

☐ under 37 CFR 1.97 (d) together with:
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☐ a \$180.00 fee set forth in 37 CFR 1.17 (p).
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☒ Applicant(s) submit herewith Form PTO 1449- Information Disclosure Citation together with
copies of patents, publications or other information of which applicant(s) are aware, which applicant(s) believe(s)
may be material to the examination of this application and for which there may be a duty to disclose in accordance
with 37 CFR 1.56.

It is requested that the information disclosed herein be made of record in this application.

Any deficiency or overpayment should be charged or credited to deposit account number 13-1703. A
duplicate copy of this sheet is enclosed.

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Respectfully submitted,

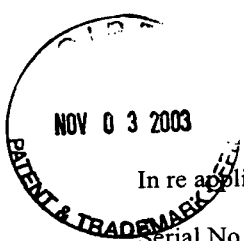
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INFORMATION DISCLOSURE CITATION
FORM PTO-1449 (Modified)

U.S. PATENT DOCUMENTS

Exam <u>Init</u>	<u>Ref</u>	Document <u>Number</u>	Issue <u>Date</u>	<u>Name</u>	<u>Class</u>	Sub <u>Class</u>
_____	_____	US 6,188,127 B1	2/13/2001	Senba, et al.		
_____	_____	6,080,931	6/27/2000	Park, et al.		

FOREIGN PATENT DOCUMENTS

Exam <u>Init</u>	<u>Ref</u>	Document <u>Number</u>	Publication <u>Date</u>	<u>Country</u>	<u>Name</u>
_____	_____	08-070079	3/12/1996	Japan	Ichiro, et al.
_____	_____	05-283608	10/29/1993	Japan	Mamoru, et al.
_____	_____	2001-028422	1/30/2001	Japan	Koyo and Yuji
_____	_____	2001-185651	7/6/2001	Japan	Hiroaki, et al.
_____	_____	08-279591	10/22/1996	Japan	Naoharu and Yuzo

OTHER DOCUMENTS

Exam <u>Init</u>	<u>Ref</u>	<u>Author, Title, Date, Pertinent Pages, Etc.)</u>
_____	_____	English language of Abstract for Japanese Patent Publication No. 08-070079, published 3/12/1996.
_____	_____	English language of Abstract for Japanese Patent Publication No. 05-283608, published 10/29/1993.
_____	_____	English language of Abstract for Japanese Patent Publication No. 2001-028422, published 1/30/2001.
_____	_____	English language of Abstract for Japanese Patent Publication No. 2001-185651, published 7/6/2001.
_____	_____	English language of Abstract for Japanese Patent Publication No. 08-279591, published 10/22/1996.

Examiner: _____

Date Considered: _____